ASSIGNMEN'	02-18-200	4 SHEET	Patents Only
To the Honorable Commissioner of P			Date: April 7, 2003 Attorney Docket No. 5649-1106
Please record the attached original do	102636261		E E C
1. Name of conveying party(ies): Sang-jin Hyun Sug-hun Hong Yu-gyun Shin	03	2. Name and address of receiving party(ies): Samsung Electronics Co., Ltd. 416 Maetan-dong, Paldal-gu Suwon-city, Kyungki-do Republic of Korea	
Additional name(s) of conveying party(ies) attach 3. Nature of conveyance:	ed? Yes X No		
X Assignment Merger Security Agreement Change of Name Other Execution Date: March 25, 2003		Additional name(s) & address(cs) attached?Yes _X_No
4. Application Serial No.	Patent No		108630
If this document is being filed together is: March 25, 2003	er with a new application, the	he execution date of the app	lication

P. O. Box 37428 Raleigh NC 27627

5. Name and address of party to whom correspondence

concerning document should be mailed:

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41) \$40.00 X Enclosed

Authorized to be charged to deposit account

8. Deposit account number: 50-0220

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9. Statement and signature

Mitchell S. Bigel

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy

of the original document.

Additional numbers attached?

Myers Bigel Sibley & Sajovec

Mitchell S. Bigel, #29,614 Name of Person Signing

Signature

Yes X No

April 7, 2003

Date

Total number of pages including cover sheet, attachments and document: 3

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PATENT REEL: 014343 FRAME: 0195

Attorney Docket No. 5649-1106

ASSIGNMENT

THIS ASSIGNMENT, made by us, Sang-jin Hyun, citizen of the Republic of Korea, residing at 304-403, Jugong Apt., Byulyang-dong, Kwacheon-city, Kyungki-do, Republic of Korea; Sug-hun Hong, citizen of the Republic of Korea, residing at 247-1104, Ssangyong Apt., Hwanggol Maeul, Youngtong-dong, Paldal-gu, Suwon-city, Kyungki-do, Republic of Korea; and Yu-gyun Shin, citizen of the Republic of Korea, residing at 134-906, Parktown Apt., 55, Sunae-dong, Bundang-gu, Sungnam-city, Republic of Korea;

WITNESSETH: That,

WHEREAS, we are the joint inventors of certain new and useful improvements in METHODS OF FABRICATING OXIDE LAYERS BY PLASMA NITRIDATION AND OXIDATION for which an application for United States Letters Patent has been filed, or is being filed concurrently, in the United States Patent and Trademark Office. We hereby authorize and request Myers Bigel Sibley & Sajovec, P.A., to insert here in parentheses (Application No. ________, filed ________) the filing date and application number of said application when known or to file this Assignment concurrently with the application; and

WHEREAS, Samsung Electronics Co., Ltd., a Korean corporation having a principal place of business at 416 Maetan-dong, Paldal-gu, Suwon-city, Kyungki-do, Republic of Korea, hereinafter referred to as assignee, is desirous of acquiring the entire right, title and interest in and to said invention as described in said application, and in and to any and all Letters Patent which shall be granted therefor in the United States of America and all foreign countries;

NOW, THEREFORE, To Whom It May Concern, be it known that for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we have sold and by these presents do hereby sell, assign, transfer, and convey unto the said assignee, its successors and assigns, the entire right, title, and interest in and to the said invention and application, and in and to any and all continuations, continuations-in-part, or divisions thereof, and in and to any and all Letters Patent of the United States of America and all foreign countries or reissues or other forms of protection thereof which may be granted therefor or thereon, for the full end of the term for which said Letters Patent may be granted along with any term extensions thereon or therefor, together with the right to claim the priority of said application in all foreign countries in accordance with the International Convention, the same to be held and enjoyed by said assignee, its successors and assigns, as fully and entirely as the same would have been held and enjoyed by us if this assignment and sale had not been made.

We hereby request that said Letters Patent be issued in accordance with this assignment.

We further covenant and agree that, at the time of the execution and delivery of these presents, we possess full title to the invention and application above-mentioned, and that we have the unencumbered right and authority to make this assignment.

We further covenant and agree to promptly communicate to said assignee or its representatives any facts known to us relating to said invention, to testify in any interference or legal proceedings involving said

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PATENT REEL: 014343 FRAME: 0196 invention, to execute any additional papers which may be requested to confirm the right of the assignee, its representatives, successors, or assigns to secure patent or similar protection for the said invention in all countries and to vest in the assignee complete title to the said invention and Letters Patent, without further compensation, but at the expense of said assignee, its successors, assigns, and other legal representatives; and we hereby instruct, and further covenant and agree to bind our heirs, legal representatives, and assigns, to do same, without further compensation, but at the expense of said assignee or its representatives.

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Date:______